

Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)
 Contact Info: ti.com/support
 Form/Declaration Type: Distribute - RoHS and IEC 62474 DB
 Created on: 05/12/2022

Details for "SN74ALS04BDBR"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
SN74ALS04BDBR	NIPDAU	Level-1-260C-UNLIM	TI MALAYSIA A/T	DB 14	5.3x6.2x1.95	149.2

*Total Device Mass
 The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

Component	Substance	CAS Number	Amount (mg)	Homogeneous Material Level		Component Level	
				Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.077591	99.998711	999987	0.051991	520
Precious Metals	Silver	7440-22-4	0.000001	0.001289	13	0.000001	0
Sub-Total			0.077592	100	1000000	0.051992	520
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	0.137682	79.999768	799998	0.092257	923
Thermoplastics	Epoxy	85954-11-6	0.034421	20.000232	200002	0.023064	231
Sub-Total			0.172103	100	1000000	0.115321	1153
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	24.502388	97.424998	974250	16.418318	164183
Copper and Its Alloys	Iron	7439-89-6	0.6036	2.4	24000	0.404454	4045
Copper and Its Alloys	Phosphorus	7723-14-0	0.003773	0.015002	150	0.002528	25
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.007545	0.03	300	0.005056	51
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.007545	0.03	300	0.005056	51
Zinc and Its Alloys	Zinc	7440-66-6	0.02515	0.1	1000	0.016852	169
Sub-Total			25.150001	100	1000000	16.852264	168523
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.04756	95.12	951200	0.031869	319
Precious Metals	Gold	7440-57-5	0.00039	0.78	7800	0.000261	3
Precious Metals	Palladium	7440-05-3	0.00205	4.1	41000	0.001374	14
Sub-Total			0.05	100	1000000	0.033504	335
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	108.438689	88	880000	72.661525	726615
Other Plastics and Rubber	Carbon Black	1333-86-4	0.369677	0.3	3000	0.24771	2477
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	0.677742	0.55	5500	0.454135	4541
Thermoplastics	Epoxy	85954-11-6	13.739675	11.15	111500	9.206546	92065
Sub-Total			123.225783	100	1000000	82.569914	825699
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	0.562635	100	1000000	0.377005	3770
Sub-Total			0.562635	100	1000000	0.377005	3770
Total			149.238114			100	1000000

Important Note

The ppm calculations are at the **homogeneous material** level and are maximum concentration values. The ppm displayed represents the **homogeneous material** with the highest ppm for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.
 The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**.
[See Glossary of Terms for more details.](#)

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSi or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

[For an explanation of the methods used to determine material weights, See Product Content Methodology.](#)

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

[For additional information, please contact TI customer support.](#)

Signature: [\(click here for a fuller statement with a signed certificate\)](#)

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 For further environmental statements, please go to www.ti.com/ecoinfo
 Created on: 05/12/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in <http://www.ti.com/lit/pdf/szzq088>

Green: Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb2O3) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.